XBS013S16R-G



ETR1604-003

Schottky Barrier Diode, 100mA, 30V Type

■FEATURES

■APPLICATIONS

Low Current Rectification

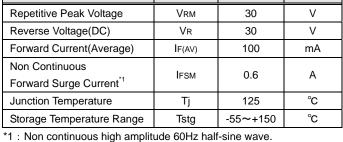
Forward Voltage : V_F=0.71V (TYP.) **Forward Current** : $I_{F(AV)}$ =100mA Repetitive Peak Reverse Voltage : V_{RM}=30V

Environmentally Friendly : EU RoHS Compliant, Pb Free

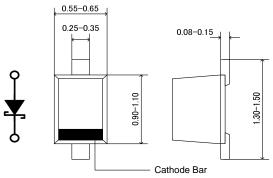
■ ABSOLUTE MAXIMUM RATINGS

■ PACKAGING INFORMATION

			14-25 0	
PARAMETER	SYMBOL	RATINGS	UNIT	
Repetitive Peak Voltage	VRM	30	V	
Reverse Voltage(DC)	VR	30	V	
Forward Current(Average)	I F(AV)	100	mA	
Non Continuous	IFSM	0.6	Α	
Forward Surge Current*1	IFSIVI	0.6	A	
Junction Temperature	Tj	125	°C	
Storage Temperature Range	Tstg	-55~+150	င	









SOD-723

■MARKING RULE



- ①: 0 (Product Number)
- 2: Assembly Lot Number

■PRODUCT NAME

PRODUCT NAME	DESCRIPTION		
XBS013S16R	SOD-723		
XBS013S16R-G	SOD-723 (Halogen & Antimony free)		

^{*} The "-G" suffix indicates that the products are Halogen and Antimony free as well as being fully RoHS compliant.

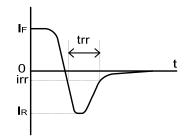
■ELECTRICAL CHARACTERISTICS

Ta=25°C

PARAMETER S	SYMBOL	TEST CONDITIONS	LIMITS			UNIT
FARAIVIETER STIVIBO		TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Forward Voltage VF1 VF2	VF1	I _F =1mA	=	0.31	-	V
	VF2	I _F =100mA	-	0.71	1	V
Reverse Current	lr	V _R =25V	-	-	2	μΑ
Inter-Terminal Capacity	Ct	$V_R=0V$, $f=1MHz$	-	6	-	pF
Reverse Recovery Time*2	trr	I _F =I _R =10mA , irr=1mA	-	2	-	ns

Ta=25°C

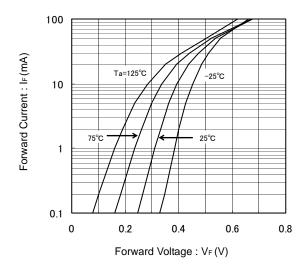
*2 : trr measurement circuit Bias Device Under Test Oscilloscope Pulse Generatrix



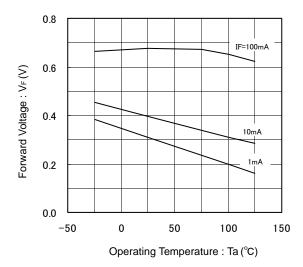
^{*} The device orientation is fixed in its embossed tape pocket.

■TYPICAL PERFORMANCE CHARACTERISTICS

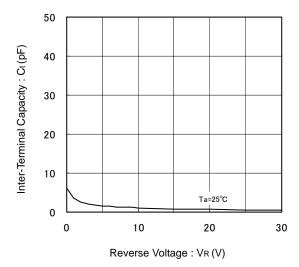
(1) Forward Current vs. Forward Voltage



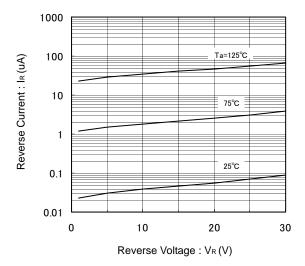
(3) Forward Voltage vs. Operating Temperature



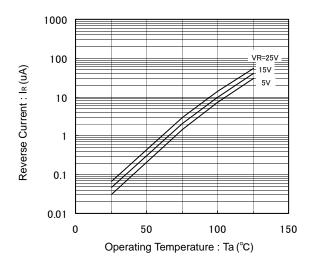
(5) Inter-Terminal Capacity vs. Reverse Voltage



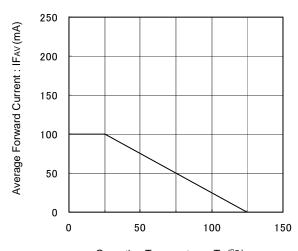
(2) Reverse Current vs. Reverse Voltage



(4) Reverse Current vs. Operating Temperature



(6) Average Forward Current vs. Operating Temperature



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